



SPECIFICATION FOR APPROVAL

CN: 0

CUSTOMER	:	_____
PRODUCT TYPE	:	SMD SEAM SEALING X'TAL 3.2×2.5
NOMINAL FREQ.	:	16.000000MHz
TXC P/N	:	AM16070303
REVISION	:	A1
CUSTOMER P/N	:	_____
PM / SALES	:	_____
DATE	:	_____
CUSTOMER CONFIRMATION	:	_____ (Signature) _____ (Date)

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

**MSL:Level 1
RoHS Compliant**

(for glass crystal only : Pb used with sealing glass material is exempt from EU directive)



PRODUCT SPECIFICATION SHEET

CN: _____

PRODUCT TYPE : SMD SEAM SEALING X'TAL 3.2×2.5

NOMINAL FREQ. : 16.000000MHz

TXC P/N : AM16070303

REVISION : A1

PE/RD	QA	MFG
<i>Wen yuan Chang</i>	<i>ZhongLin Wu</i>	<i>Zhi Jun Wu</i>
Wen yuan Chang	ZhongLin Wu	Zhi jun Wu
<i>8-Mar-17</i>	<i>8-Mar-17</i>	<i>8-Mar-17</i>

NOTE:

- (1) TXC green product standard is based on the international standards. Relevant information is posted on the TXC website and updated regularly. The documentation is subject to the latest green product quality system.
- (2) Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3) Revision "Ax" is production ready. PE, QA and MFG's approval required.

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Rev	Revise page	Revise contents	Date	Ref.No.	Reviser
S1	N/A	Initial released	21-Sep-16	N/A	Xiaohua Zhang
A1	N/A	S Turn A	8-Mar-17	N/A	Xiaohua Zhang

Spec Sheet Contents

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■ ELECTRICAL SPECIFICATIONS

Standard conditions

Ambient temperature : $25 \pm 5^{\circ}\text{C}$

Relative humidity : 40%~70%

In addition to special specifications, are measured in the standard environment.

Ambient temperature : $25 \pm 3^{\circ}\text{C}$

Relative humidity : 40%~70%

If there is any doubt about the result, it is necessary to make measurements in the standard environment.

Measure equipment

Electrical characteristics measured by S&A 250B or equivalent.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

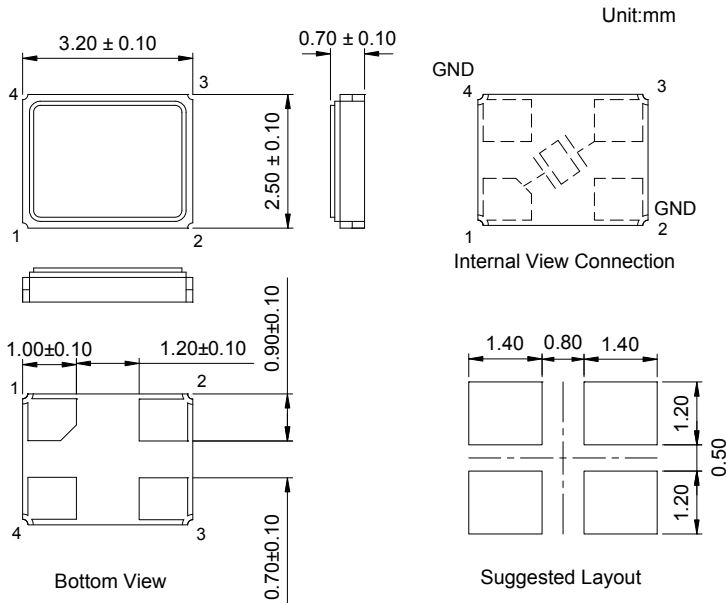
Unit Weight:

0.018±0.001 g/pcs

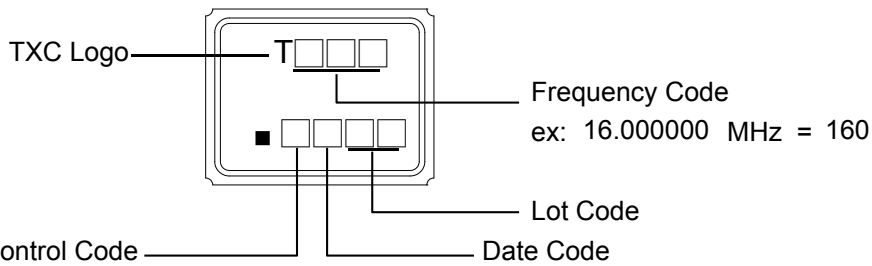
	Parameters	SYM.	Electrical Spec.				Notes
			MIN	TYPE	MAX	UNITS	
1	Nominal Frequency	FL	16.000000			MHz	-
2	Oscillation Mode	-	Fundamental			-	-
3	Load Capacitance	CL	8			pF	-
4	Frequency Tolerance	-	±15			ppm	at $25^{\circ}\text{C} \pm 3^{\circ}\text{C}$
5	Frequency Stability	-	±50			ppm	Over Operating Temp. Range (Reference 25°C)
6	Operating Temperature	-	-40	~	125	$^{\circ}\text{C}$	-
7	Aging	-	-3	~	+ 3	ppm	1st Year
8	Drive Level	DL	-	10	200	μW	-
9	Effective Resistance Rr	Rr	-	-	120	Ω	-
10	Shunt Capacitance C0	C0	0.77±30%			pF	-
11	Motional Capacitance C1	C1	2.39±30%			fF	-
12	Motional inductance L1	L1	41.44±30%			mH	-
13	Insulation Resistance	-	500	-	-	M Ω	at DC 100V
14	Storage Temperature Range	-	-40	~	125	$^{\circ}\text{C}$	-

■ DIMENSIONS

(Unit:mm)



■ MARKING



Month Code:

YEAR					MONTH											
					JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2005	2009	2013	2017	2021	A	B	C	D	E	F	G	H	J	K	L	M
2006	2010	2014	2018	2022	N	P	Q	R	S	T	U	V	W	X	Y	Z
2007	2011	2015	2019	2023	a	b	c	d	e	f	g	h	j	k	l	m
2008	2012	2016	2020	2024	n	p	q	r	s	t	u	v	w	x	y	z

*This month code will be cycled every four years

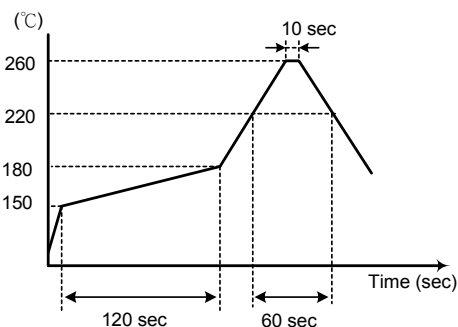
Production location: Taiwan & China (NGB)

■ SUGGESTED REFLOW PROFILE

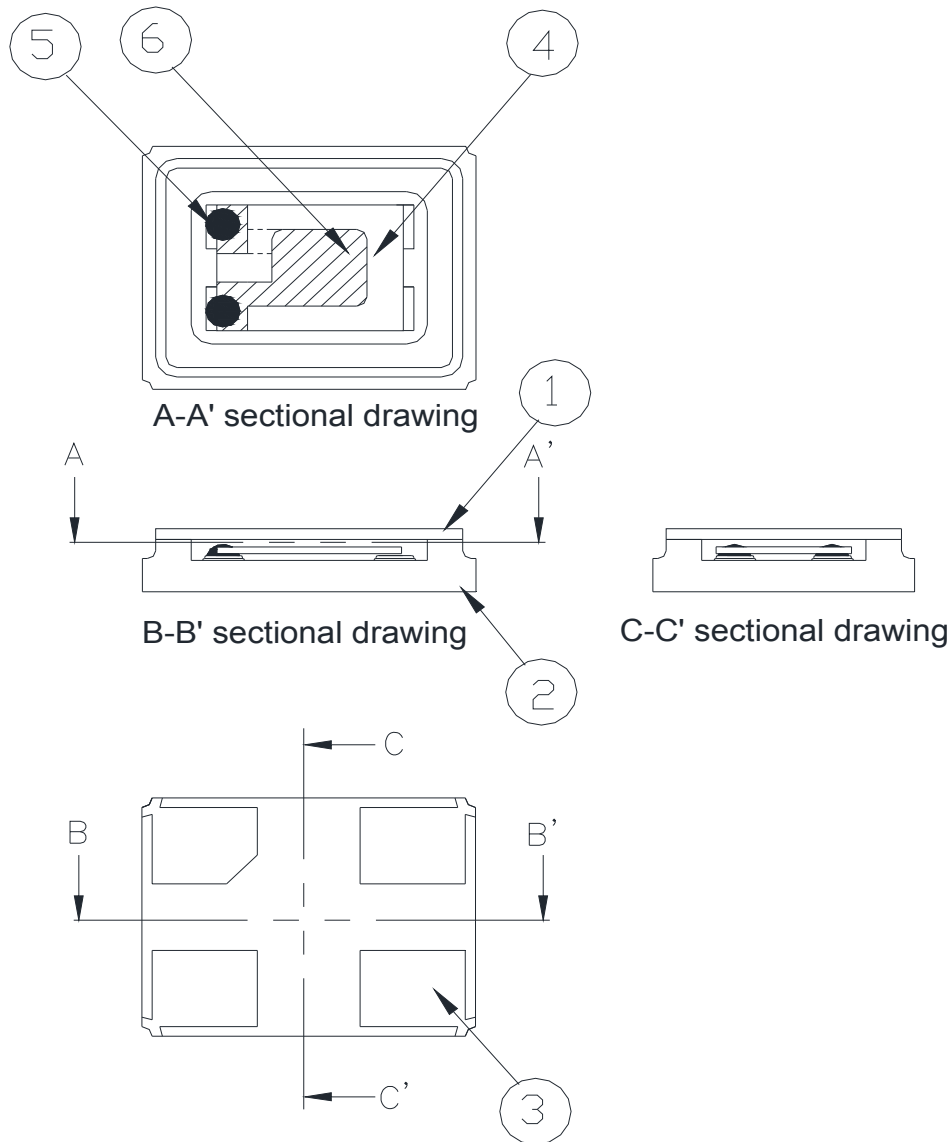
Peak Temperature : 260±5°C, 10 sec. Max.
Solder melting point : 220±10 °C, 60 sec. Min.

■ SUGGESTED MANUAL SOLDER CONDITION

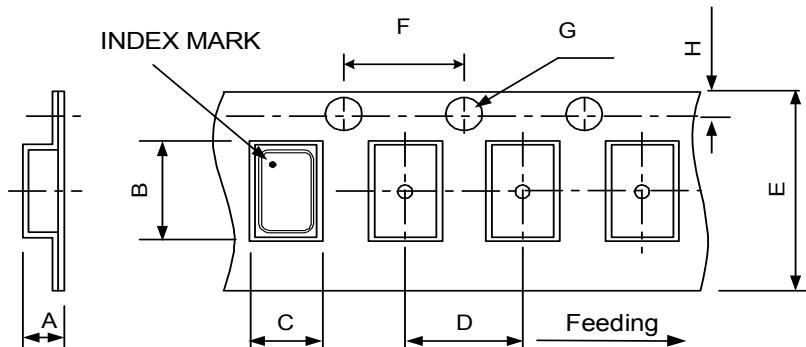
Temperature: 350 ± 10 °C
Time: 3 sec.
Re-solder times: twice



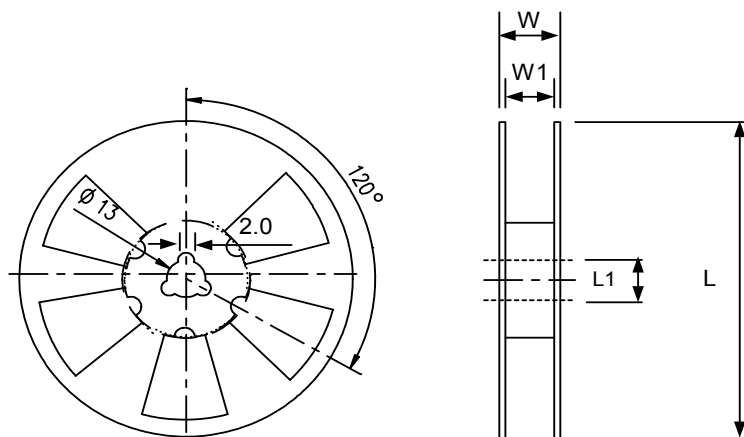
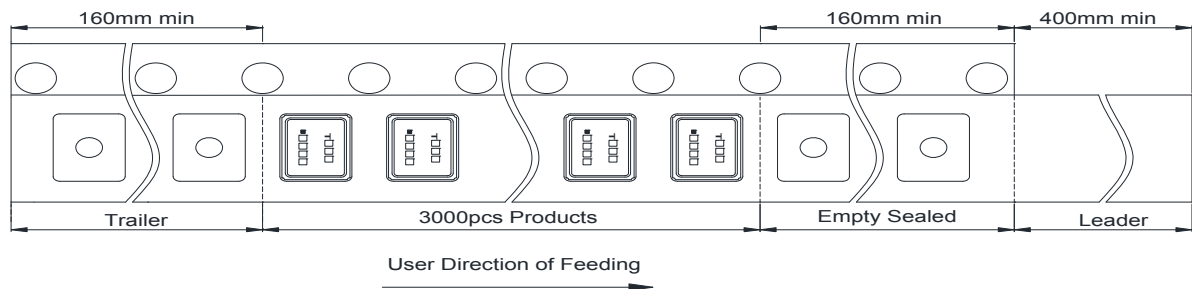
NOTE: After manual welding, the product shall be measured down to room temperature.

■ STRUCTURE ILLUSTRATION


NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Lid	Kovar (Fe/Co/Ni)	-
2	Base(Package)	Ceramic (Al ₂ O ₃) + Kovar (Fe/Co/Ni)+ Ag/Cu	Color black
3	PAD	Au	Tungsten metalize + Ni plating + Au plating
4	Crystal blank	SiO ₂	-
5	Conductive adhesive	Ag	Silicon resin
6	Electrode	Noble Metal	-

PACKING


DIMENSIONS	A	B	C	D	E	F	G	H	(UNIT : mm)
	1.65	3.40	2.70	4.00	8.00	4.00	1.50	1.75	

REMARK :


DIMENSIONS	L	L1	W	W1	pcs / Reel (UNIT : mm)
	178.0	13.0	11.5	8.0	Standard Reel Quantity is 3,000 pcs per reel

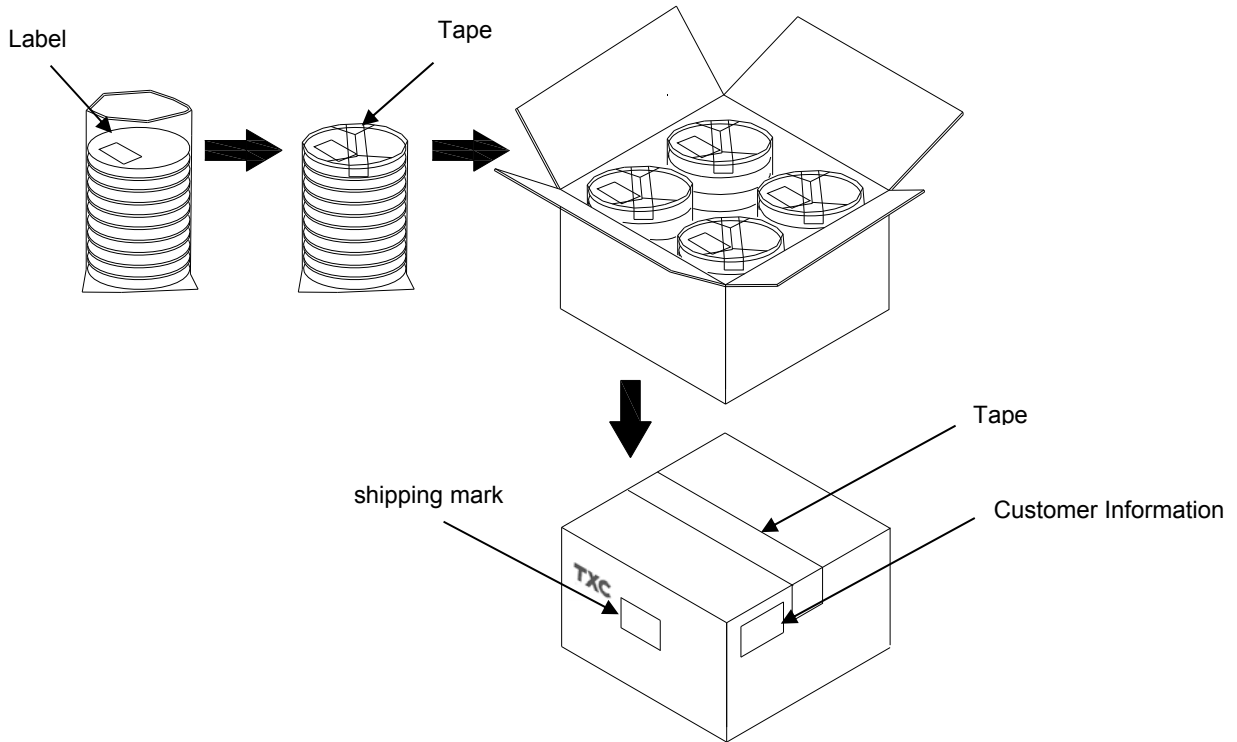
■ PACKING

Box Item:

- 1. Reel X 6 (L200 X W200 X H140mm)
- 2. Reel X 12 (L200 X W200 X H250mm)
- 3. Reel X 25 (L400 X W400 X H280mm)
- 4. Reel X 50 (L400 X W400 X H280mm)
- 5. Reel X 100 (L399 X W346 X H360mm)

Note:

- 1. For the maximum reel of loads for each type box.
- 2. The number of reels is slightly adjusted according to each factory.



Label :

TXC CORPORATION		QA PASS
DATE CODE:	Q' TY:	<input type="text"/>
LOT NO:		
PART NO:	RoHS	
FREQ: <input type="text"/>	HF	

[STORAGE]

- 1. Do not get wet by the rain.
- 2. The storage environment shall be 5°C ~40°C and 30% ~ 75%RH humidity and avoid exposure to sunlight.
- 3. If customers have special requirements, we can coordinate.

■ RELIABILITY SPECIFICATIONS (AEC-Q200 Compliant)

1. Mechanical Endurance

No.	Test Item	Test Methods	REF.DOC
1.1	Drop Test	120 cm height, 10 times on Stainless Plate .	JIS C 6701
1.2	Mechanical Shock	Device are shocked to half sine wave (3000 G) three mutually perpendicular axes each 3 times. 0.3m sec. duration time	MIL-STD-202 Method 213
1.3	Vibration	Frequency range 10 ~ 2000 Hz~10 Hz Amplitude 1.52 mm/10G Sweep time 20 minute Perpendicular axes each test time 4 Hrs (Total test time 12 Hrs)	MIL-STD-202 Method 204
1.4	Solderability	Temperature 245 °C ± 5°C Immersing depth 1.25 mm Immersion time 5 ± 1 seconds Flux Rosin resin methyl alcohol solvent (1 : 4)	J-STD-002
1.5	Terminal Strength	Mount on PCB board and shear strength 1.8kg for 60 sec.	AEC-Q200-006
1.6	Board Flex	Duration Time: 60 sec, Deviation: 3mm	AEC-Q200-005

2. Environmental Endurance

No.	Test Item	Test Methods	REF. DOC
2.1	Resistance To Soldering Heat	Pre-heat temperature 125 °C Pre-heat time 60 ~ 120 sec. Test temperature 260 ± 5 °C Test time 10 ± 1 sec.	MIL-STD 202 Method 210
2.2	High Temp. Storage	+ 105 °C ± 3 °C for all 1000 Hrs.	MIL-STD-202 Method 108
2.3	Low Temp. Storage	- 40 °C ± 3 °C for all 1000 Hrs.	JIS C 6701
2.4	Thermal Shock	Total 1000 cycles of the following Thermal Shock : 	MIL-STD-202 Method 107
2.5	Temperature Cycle	Total 1000 cycles of the following temperature cycle : - 40°C ± 3 to 105°C ± 3 , Dwell time:15min.	JESD 22 Method JA-104
2.6	Biased Humidity	+ 85°C ± 3°C , RH 85% , 1000 Hrs.	MIL-STD-202 Method 103
2.7	Moisture Resistance	20 cycles (+25°C~65°C , 80%~100% RH) , 24hrs/cycle.	MIL-STD 202 Method 106
2.8	Operational Life	+ 105 °C ± 3 °C for 1000 Hrs.	MIL-STD-202 Method 108